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Approved by:

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Issued by:

SPECIFICATION

PRODUCT: SAW FILTER

MODEL: HDBF36A3D



SHOULDER ELECTRONICS LIMITED

1.SCOPE

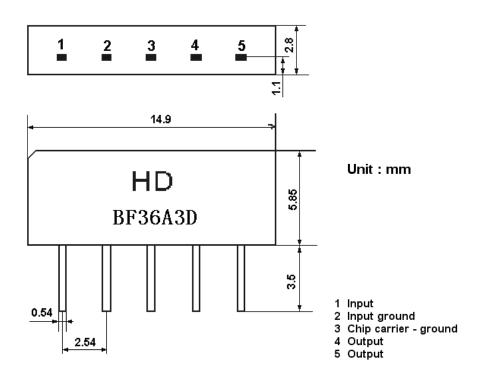
SHOULDER'S SAW filter series have broad line up products meeting all broadcast standard including NTSC,PAL and SECAM systems. These filters are composed of two interdigital transducers on a single-crystal. piezoelectrical chip. they are used in electronic equipments such as TV and so on.

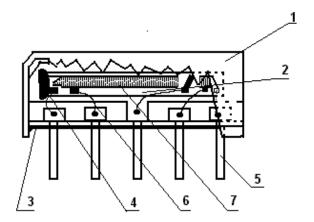
2. Construction

2.1 Dimension and materials

Manufacturer's name: SHOULDER ELECTRONICS LTD(CHINA)

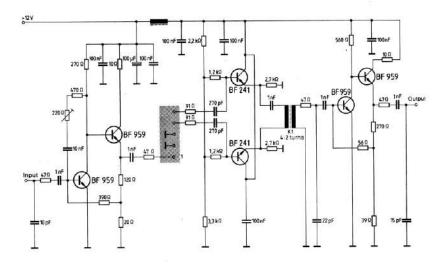
Type: BF36A3D





Components	Materials
1.Outer casing	PPS
2.Substrate	Lithium niobate
3.Base	Epoxy resin
4.Absorber	Epoxy resin
5.Lead	Cu alloy+Au plate
6.Bonding wire	AlSi alloy
7.Electrode	Al

2.2. Circuit construction, measurement circuit



Test circuit for SIP-5 filter Input impedance of the symmetrical post-amplifier: 2 k Ω in parallel with 3 pF

3. Characteristics

Items	Conditions	Specifications
Standard atmospheric conditions	Unless otherwise specified, the standard rang of atmospheric conditions for making measurements and tests is as follows; Ambient temperature : 15°C to 35°C Relative humidity : 25% to 85% Air pressure : 86kPa to 106kPa	
Operating temperature rang	Operating temperature rang is the rang of ambient temperatures in which the filter can be operated continuously. $-10^{\circ}\text{C} \sim +60^{\circ}\text{C}$	There shall be no damage.
Storage temperature rang	Storage temperature rang is the rang of ambient temperatures at which the filter can be stored without damage. Conditions are as specified elsewhere in these specifications. $-40^{\circ}\text{C} \sim +70^{\circ}\text{C}$	
Reference temperature	+25°C	

3.1 Maximum Rating

DC voltage	VDC	12	V	Between any terminals
AC voltage	Vpp	10	V	Between any terminals

3.2 Electrical Characteristics

Source impedance $Zs=50 \Omega$

Load impedance $Z_L=2k \Omega //3pF$ $T_A=25 ^{\circ}C$

1 """						
Item		Freq	min	typ	max	
Center fre	quency	Fo	-	36.125	-	MHz
Insertion attenuation Reference level		36.125MHz	13.0	15.0	17.0	dB
Page ha	ndwidth	B_{3dB}	5.9	6.1	-	MHz
r ass ua	mawiam	$\mathbf{B}_{30\mathrm{dB}}$	ı	7.8	8.0	MHz
		33.59MHz	-1.4	0.1	1.6	dB
Dolotivo ett	anuation	38.65MHz	-1.1	0.4	1.9	dB
Kelative att	Relative attenuation		1.0	2.5	4.0	dB
		39.12MHz	1.6	3.1	4.6	dB
Cidalaha	25.00~	32.00MHz	33.0	40.0		dB
Sidelobe	40.20~45.00MHz		35.0	40.0		dB
Group delay ripple(p-p) 33.12~39.12MHz		-	40	-	ns	
Temperature coefficient			-72		ppm/k	

3.3 Environmental Performance Characteristics

Item	Conditio	n		Specifications
High	The specimen shall be store	The specimen shall be store at a temperature of		
temperature	80±2℃ for 96±4h. Then it	for 96±4h. Then it shall be subjected to		
	standard atmospheric cond	l atmospheric conditions for 1h, after		
	which measurement shall be	made within 1h.		
Low	The specimen shall be store	e at a temperatur	re of	
temperature	-20±3°C for 96±4h. Then i	t shall be subjecte	ed to	
	standard atmospheric cond	litions for 1h,	after	
	which measurement shall be	made within 1h.		
Humidity	The specimen shall be store	e at a temperatur	re of	3.6 1 1 1
	40±2°C with relative humid	dity of 90% to	96%	Mechanical characteristics and
	for 96±4h. Then it shall be	96±4h. Then it shall be subjected to standard		
	atmospheric conditions for	pheric conditions for 1h, after which		
	measurement shall be made	measurement shall be made within 1h.		
Thermal	The specimen shall be subjected to 8 continuous he satisfied. The			characteristics shall
shock	cycles each as shown below. Then it shall be shall be no			
	subjected to standard atmospheric conditions for excessive change			excessive change in
	In, after which measurement shall be made appearance			
	within Th.			appearance.
	Temperature	Duration		
	$1 +25 \degree C = >-40 \degree C$	0.5h		
	2 -40 ℃	4h		
	3 -40 °C=>+85 °C	2h		

	4 +85 °C	4h	
	5 +85 °C=>+25 °C	0.5h	
	6 +25 °C	1h	
Resistance to	Reflow soldering method		
Soldering	Peak: 255 ± 5 °C, 220 ± 5 °C	C, 40s	
heat	At electrode temperature of t	he specimen.	
	300-	shown in the above stored at standar 1h, after which the Test board shall be	v e d e e
Solder ability	Immerse the pins melt sole	der at 260°C+5/-0°C	More then 95% of
	for 5 sec.		total area of the
			pins should be
			covered with solder

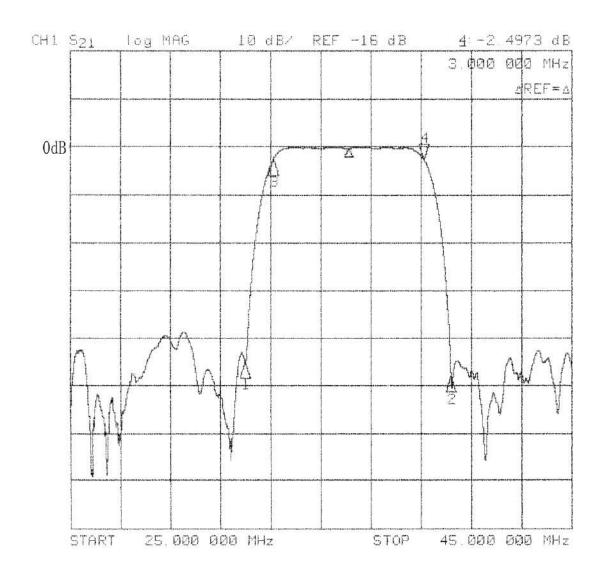
3.4 Mechanical Test

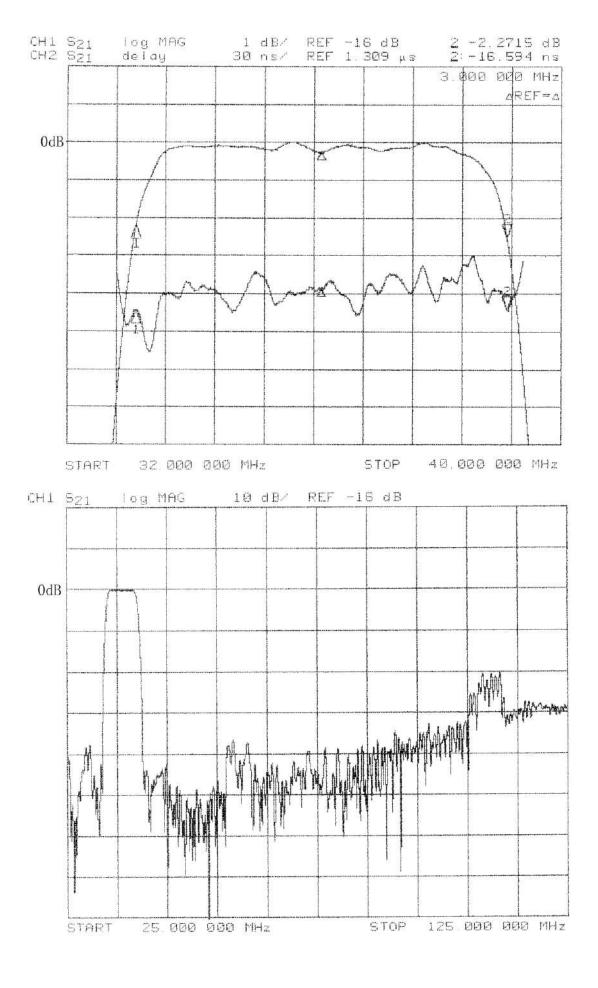
Items	Conditions	Specifications
Vibration	600-3300rpm amplitude 1.5mm	
	3 directions 2 H each	
Drop	On maple plate from 1 m high 3 times	
		There shall be no
Lead pull	Pull with 1 kg force for 30 seconds	damage.
Lead bend	90° bending with 500g weigh 2 times	

3.5 Voltage Discharge Test

5.5 Voltage Discharge Test				
Item	Condition	Specifications		
Surge	Between any two electrode			
	1000pF 4Mohm	There shall be no damage		

3.6 Frequency response:





Time domain response:

